

Docket No. 3008-0028
File No. 521.41457X00
Client No. PHCF-01094

2200
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of
AOYAMA, et al.
Serial No: 09/892,630
Filed: June 28, 2001

EXPEDITED PROCESSING REQUESTED

: Art Unit: 2841
: Examiner: T. Dinh

For: LEAD-FREE SOLDER, AND CONNECTION LEAD AND ELECTRICAL
COMPONENT USING SAID LEAD-FREE SOLDER

AMENDMENT UNDER 37 CFR 1.116

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

July 18, 2005

Sir:

This Amendment is filed in response to the final Official Action dated May 18, 2005, the time for response to which is up to and including August 18, 2005. Please amend the above-identified application as listed below and as set forth on the following pages.

Amendments to the Claims

Remarks are included following the amendments